



VT-901

UL Approval: E214381 Version: B7 /40 /41

Laminate/Prepreg

General Information

- > Tg 250°C
- > High Td
- > Improved Fracture Toughness
- > Low Z-axis CTE
- > Meets NASA requirements for no visible bromine



Application

- > Chip Manufacturers
- > Engine/Flight Controls
- > Power Supply/Backplane
- > Military and Burn-in Board

Availability

- > Core Thickness: 0.002" (0.05mm) to 0.125" (3mm), available in sheet or panel form
- > Copper Foil: 1/4oz to 6oz
- > Prepregs are available in roll or panel form
- > E-Glass styles: 7628, 1506, 2113, 2313, 3313, 2116, 1080, 106 etc

Properties		Prepreg		Laminate
Storage Condition	Temperature	Below 23°C (73°F)	Below 5°C (41°F)	Room
	Relative humidity	Below 55% RH	/	/
Shelf Life		3 months	6 months	24 months (airproof)

The prepreg exceeding shelf life should be retested.

CORPORATE HEADQUARTERS

Ventec Electronics Co. Ltd.
308 TaiShan Rd,
New District Suzhou,
Jiangsu, P.R. China 215129
T: +86 512-68091810
Email: sales@ventec.com.cn

EMEA REGIONAL HEADQUARTERS

Ventec Europe
Unit 1 Trojan Business Centre,
Tachbrook Park Estate,
Leamington-Spa, CV34 6RH, UK
T: +44 1926-889822
Email: sales@ventec-europe.com

AMERICAS REGIONAL HEADQUARTERS

Ventec USA
720 Lee St., Elk Grove Village,
Illinois, IL 60007,
United States of America
T: +1 630-4221627
Email: saleseast@ventec-usa.com

www.ventec laminates.com

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Properties Sheet IPC-4101E /40 /41

Properties	Test Method	Units	Specification	Typical Value	
Thermal Properties					
Tg	DSC	IPC-TM-650 2.4.25	°C	-	
	TMA	IPC-TM-650 2.4.24	°C	200 minimum 250	
Td	ASTM D3850	°C	-	395	
T260	IPC-TM-650 2.4.24.1	Minute	-	>60	
T288	IPC-TM-650 2.4.24.1	Minute	-	>60	
Thermal Stress @ 288°C	IPC-TM-650 2.4.13.1	Second	Pass 10s	>1200	
Z-axis CTE	Before Tg	IPC-TM-650 2.4.24	ppm/°C	-	50
	After Tg	IPC-TM-650 2.4.24	ppm/°C	-	150
	Total Expansion (50~260°C)	IPC-TM-650 2.4.24	%	-	1.4
X-Y CTE	IPC-TM-650 2.4.24	ppm/°C	-	11~12	
MOT	UL 94	°C	-	140	
Electrical Properties					
DK @ 1GHz RC 40%	IPC-TM-650 2.5.5.9	-	5.4 maximum	4.05	
DF @ 1GHz RC 40%	IPC-TM-650 2.5.5.9	-	0.035 maximum	0.012	
Volume Resistivity	After Moisture Resistance	IPC-TM-650 2.5.17.1	MΩ-cm	1.0E+6 minimum	5.0E+8
	E-24/125	IPC-TM-650 2.5.17.1	MΩ-cm	1.0E+6 minimum	5.0E+6
Surface Resistivity	After Moisture Resistance	IPC-TM-650 2.5.17.1	MΩ	1.0E+6 minimum	5.0E+7
	E-24/125	IPC-TM-650 2.5.17.1	MΩ	1.0E+6 minimum	5.0E+6
Electrical Strength	IPC-TM-650 2.5.6.2	Volt/mil (KV/mm)	762 (30) minimum	1200~1400 (54)	
Dielectric Breakdown	IPC-TM-650 2.5.6	KV	40 minimum	60	
Comparative Tracking Index (CTI)	ASTM D3638	Rating (Volt)	-	Grade 4 (100~175)	
Arc Resistance	ASTM D495	Second	120 minimum	150	
Mechanical Properties					
Peel Strength (1oz)	RTF	IPC-TM-650 2.4.8	lb/in (N/mm)	-	5~8 (0.88~1.40)
	HTE	IPC-TM-650 2.4.8	lb/in (N/mm)	5.14 (0.90) minimum	6~9 (1.05~1.58)
Flexural Strength	Warp	IPC-TM-650 2.4.4	Kpsi (MPa)	60 (415) minimum	600 (87)
	Fill	IPC-TM-650 2.4.4	Kpsi (MPa)	47 (325) minimum	500 (72)
Physical Properties					
Moisture Absorption	IPC-TM-650 2.6.2.1	%	1.0 maximum	0.2	
Flammability	UL-94	Rating	HB minimum	V-0	

Note: All test data provided are typical values and are not intended to be specification values.

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